

## REMARKS

Claim 21 was rejected over Najafi under Section 102. Claim 21 calls for a first semiconductor structure that has the following elements:

1. front and back sides;
2. a microelectromechanical system formed on said front side;
3. a second structure bonded to said first structure;
4. an open area under said system; and
5. a film applied to the backside of the first semiconductor structure.

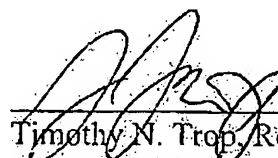
It is indicated that, in Najafi, the first structure is substrate 2, for example in Figure 2F. However, this will not work because the first structure does not have item 2 above, which is the microelectro-mechanical system. If the Examiner were to contend that the sense chip 1 is the first structure, then the film is not applied to the backside of such a first structure (see item 5 above). Either way, there is simply no way that claim 21 can be anticipated by the cited reference.

Therefore, reconsideration is respectfully requested.

In view of these remarks, the application is now in condition for allowance.

Respectfully submitted,

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